



40V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _C = +25°C
-40V	$25m\Omega$ @ V _{GS} = -10V	-28A
-4 07	$45m\Omega @ V_{GS} = -4.5V$	-21A

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Motor controls
- Backlighting
- DC-DC converters
- Printer equipment

Features and Benefits

- Low Rds(ON) Minimizes Conduction Losses
- Fast Switching Speed Minimizes Switching Losses
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

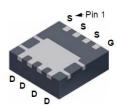
Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.0172 grams (Approximate)

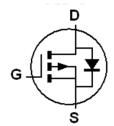




Top View



Bottom View



Device Symbol

Ordering Information (Note 4)

Part Number	Bookago	Packing		
Part Number	Package	Qty.	Carrier	
DMP4026SFG-7	PowerDI3333-8	2,000	Reel	
DMP4026SFG-13	PowerDI3333-8	3,000	Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



P46 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 3 = 2023)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	2	3	4	5	6	7	8	9	0	1	2	3
Week 1-26				27-52			53					
Code	Code A-Z		a-z			z						
Internal Code	Sı	ın	Mor	1	Tue	'	Wed	Thu		Fri		Sat
Code	7	Γ	U		V		W	X		Υ		Z



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	-40	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 6), VGS = -10V	Tc = +25°C	lο	-28	
Tc = +70°C		טו	-22	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	-28	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-113		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	lsм	-113		
Avalanche Current, L = 0.3mH	las	-20	Α	
Avalanche Energy, L = 0.3mH		Eas	65	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	48	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	33	W
Thermal Resistance, Junction to Case (Note 6)	Steady State	Rejc	3.8	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

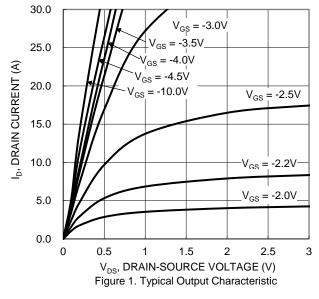
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$I_D = -250\mu A$, $V_{GS} = 0V$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1.0	μΑ	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.8	_	-1.8	V	$I_D = -250\mu A$, $V_{DS} = V_{GS}$	
Static Drain-Source On-Resistance	D		15	25	mΩ	$V_{GS} = -10V, I_{D} = -3A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	18	45	11122	$V_{GS} = -4.5V$, $I_{D} = -3A$	
Diode Forward Voltage	VsD	_	-0.7	-1.0	V	Is = -1A, VGS = 0V	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		2275			\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Output Capacitance	Coss		215	_	pF	$V_{DS} = -20V$, $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	197	_		I = IIVII IZ	
Gate Resistance	R_g		2.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -10V)	Qg	_	48	_			
Total Gate Charge (VGS = -4.5V)	Qg	_	25	_	nC	\/ 20\/ I- 2A	
Gate-Source Charge	Qgs	_	4	_	IIC	$V_{DS} = -20V, I_{D} = -3A$	
Gate-Drain Charge	Qgd	_	8	_			
Turn-On Delay Time	tD(ON)	_	4.5	_			
Turn-On Rise Time	t _R	_	5.6	_		$V_{DD} = -20V, V_{GS} = -10V$	
Turn-Off Delay Time	tD(OFF)	_	75	_	ns	$I_D = -3A$	
Turn-Off Fall Time	tr		26	_			
Body Diode Reverse Recovery Time	trr	_	18.5	_	ns	$I_S = -3A$, $di/dt = 100A/\mu s$	
Body Diode Reverse Recovery Charge	Qrr	_	9.5	—	nC	Is = -3A, di/dt = 100A/μs	

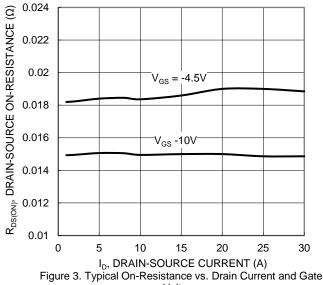
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.







Voltage

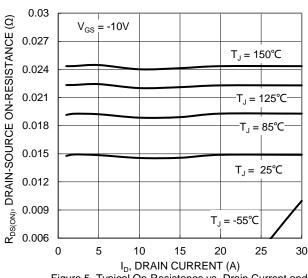
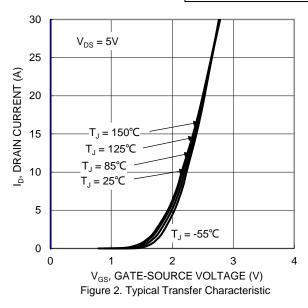
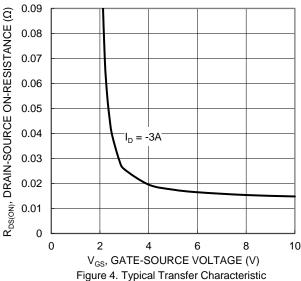


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





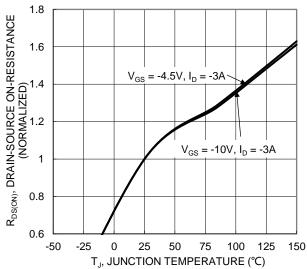


Figure 6. On-Resistance Variation with Junction Temperature



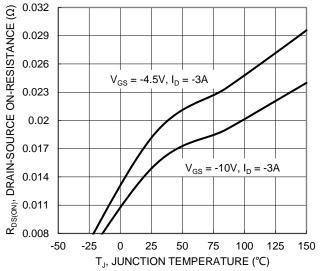


Figure 7. On-Resistance Variation with Junction Temperature

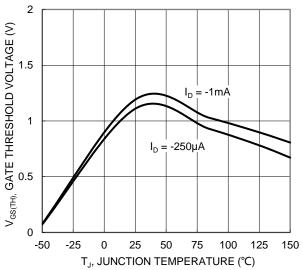
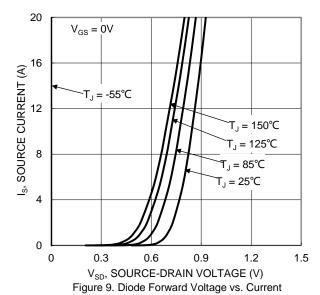
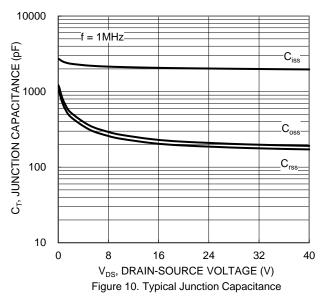
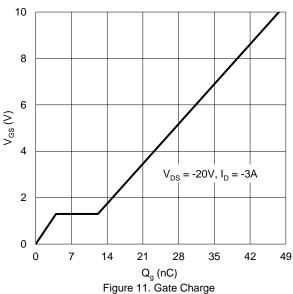


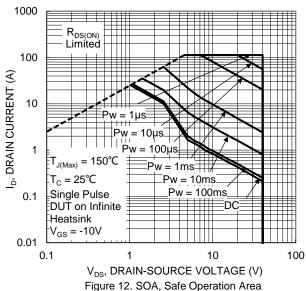
Figure 8. Gate Threshold Variation vs. Junction Temperature



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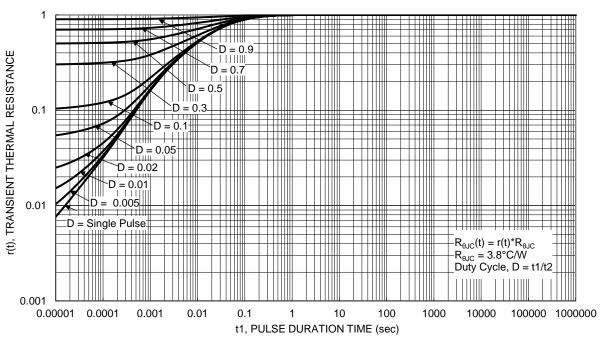


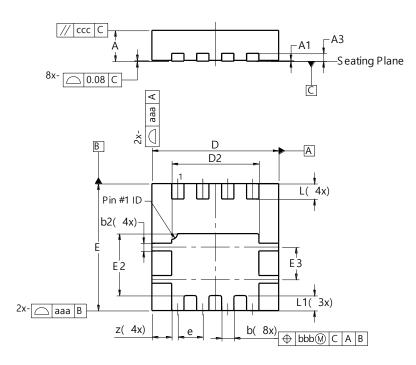
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

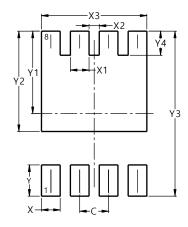


PowerDI3333-8							
Dim							
			Тур				
Α	0.75	0.85	0.80				
A1	0.00	0.05	0.02				
A 3	-	I	0.203				
b	0.27	0.37	0.32				
b2	1	-	0.20				
D	3.25	3.35	3.30				
D2	2.22	2.27					
E	3.25 3.35 3.30						
E2	1.56 1.66 1.6°						
E3	0.79 0.89 0.8						
е	0.69						
L	0.35	0.45	0.40				
L1	1	0.39					
Z	0.515						
aaa	0.25						
bbb	0.10						
CCC	0.10						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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